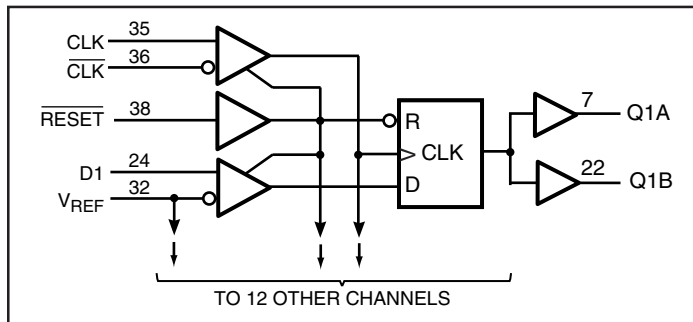


Product Features

- PI74 SSTVF16859A is designed for low-voltage operation, 2.5V for PC1600~PC2700; 2.6V for PC3200
- Supports SSTL_2 Class I specifications on outputs
- All Inputs are SSTL_2 Compatible, except RESET which is LVC MOS.
- Designed for DDR Memory
- Flow-Through Architecture
- Package: 56-pin, Plastic Very Thin Fine Pitch Quad Flat No-Lead QFN (ZB). (Pb-free available)

Logic Block Diagram



Truth Table⁽¹⁾

Inputs				Outputs
RESET	CLK	CLK	D	Q
L	X or Floating	X or Floating	X or Floating	L
H	↑	↓	H	H
H	↑	↓	L	L
H	L or H	L or H	X	Q ₀ ⁽²⁾

Notes:

1. H = High Signal Level
L = Low Signal Level
↑ = Transition LOW-to-HIGH
↓ = Transition HIGH-to-LOW
X = Irrelevant or floating
2. Output level before the indicated steady state input conditions were established.

Product Description

Pericom Semiconductor's PI74SSTVF16859A logic circuit is produced using the Company's advanced sub-micron CMOS technology, achieving industry leading speed.

All inputs are compatible with the JEDEC standard for SSTL_2, except the LVC MOS reset (RESET) input. All outputs are SSTL_2, Class II compatible.

The device operates from a differential clock (CLK and CLK). Data registered at the crossing of CLK going HIGH, and CLK going LOW.

The PI74SSTVF16859A supports low-power standby operation. When RESET is LOW, the differential input receivers are disabled, and undriven (floating) data, clock and reference voltage (VREF) inputs are allowed. In addition, when RESET is LOW, all registers are reset, and all outputs are forced LOW. The LVC MOS RESET input must always be held at a valid logic HIGH or LOW level.

To ensure defined outputs from the register before a stable clock has been supplied, RESET must be held in the LOW state during power up.

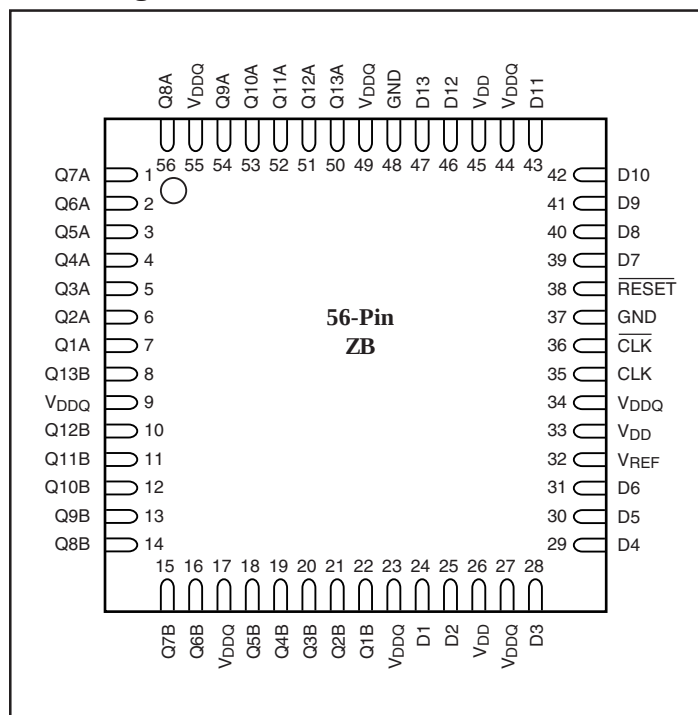
In the DDR DIMM application, RESET is specified to be completely asynchronous with respect to CLK and CLK. Therefore, no timing relationship can be guaranteed between the two. When entering RESET, the register will be cleared and the outputs will be driven LOW quickly, relative to the time to disable the differential input receivers, thus ensuring no glitches on the output. However, when coming out of RESET, the register will become active quickly, relative to the time to enable the differential input receivers. When the data inputs are LOW, and the clock is stable, during the time from the LOW-to-HIGH transition of RESET until the input receivers are fully enabled, the design must ensure that the outputs will remain LOW.

Pericom's PI74SSTVF16859A is characterized for operation from 0°C to 70°C.

Product Pin Description

Pin Name	Description
RESET	Reset (Active Low) LVC MOS
CLK	Clock Input, Positive Differential Input
CLK	Clock Input, Negative Differential Input
D	Data Input, D1-D13
Q	Data Output, Q1-Q13
GND	Ground
VDD	Core Supply Voltage
VDDQ	Output Supply Voltage
VREF	Input Reference Voltage

Pin Configuration



Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

1. The input and output negative voltage ratings may be excluded if the input and output clamp ratings are observed.
2. This value is limited to 3.6V Maximum.
3. The package thermal impedance is calculated in accordance with JESD51.

Maximum Ratings (Above which the useful life may be impaired. For user guidelines, not tested.)

Item	Symbol/ Conditions	Ratings	Units
Storage Temperature	T_{stg}	-65 to 150	°C
Supply Voltage	V_{DD} or V_{DDQ}	-0.5 to 3.6	V
Input Voltage ^(1,2)	V_I	-0.5 to V_{DD} +0.5	
Output Voltage ^(1,2)	V_O	-0.5 to V_{DDQ} +0.5	
Input Clamp Current	$I_{IK}, V_I < 0$ or $V_I > V_{DD}$	±50	mA
Output Clamp Current	$I_{OK}, V_O < 0$ or $V_O > V_{DDQ}$	±50	
Continuous Output Current	$I_{OZ}, V_O = 0$ to V_{DDQ}	±50	
V_{DD}, V_{DDQ} or GND Current/Pin	I_{DD}, I_{DDQ} or I_{GND}	±100	°C/W
Package Thermal impedance ⁽³⁾ A Package	J_A	55	
2 B-Package		24	

Recommended Operating Conditions⁽⁴⁾

Parameters	Description		Min.	Nom.	Max.	Units
V _{DD} /V _{DDQ}	Core Output Supply Voltage	PC1600 PC2700	2.3	2.5	2.7	V
	I/O Supply Voltage	PC3200	2.5	2.6	2.7	
V _{REF}	Reference Voltage V _{REF} = 0.5X V _{DDQ}	PC1600 PC2700	1.15	1.25	1.35	
		PC3200	1.25	1.3	1.35	
V _{TT}	Termination Voltage		V _{REF} −0.04	V _{REF}	V _{REF} +0.04	
V _I	Input Voltage		0		V _{DD}	
V _{IH}	AC High -Level Input Voltage	Data Inputs	V _{REF} +310mV			
V _{IL}	AC Low -Level Input Voltage				V _{REF} − 310mV	
V _{IH}	DC High -Level Input Voltage		V _{REF} +150mV			
V _{IL}	DC Low -Level Input Voltage				V _{REF} −150mV	
V _{IH}	High -Level Input Voltage	$\overline{\text{RESET}}$	1.7			
V _{IL}	Low -Level Input Voltage				0.7	
V _{ICR}	Common-mode input range	CLK, $\overline{\text{CLK}}$	0.97		1.53	
V _{ID}	Differential Input Voltage		0.36			
I _{OH}	High-Level Output Current				−16	mA
I _{OL}	Low-Level Output Current				16	
T _A	Operating Free-Air Temperature		0		70	°C

Note:

4. The $\overline{RESET}$ input of the device must be held at V_{DD} or GND to ensure proper device operation. The differential inputs must not be floating, unless $\overline{RESET}$ is LOW.

DC Electrical Characteristics for PC1600~PC2700

(Over the Operating Range, $T_A = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{DD} = 2.5\text{V} \pm 200\text{mV}$, $V_{DDQ} = 2.5\text{V} \pm 200\text{mV}$)

Parameters		Test Conditions	V_{DD}	Min.	Typ.	Max.	Units
V_{IK}		$I_I = -18\text{mA}$	2.3V			- 1.2	V
V_{OH}		$I_{OH} = -100\mu\text{A}$	2.3V- 2.7V	$V_{DD} - 0.2$			
		$I_{OH} = -8\text{mA}$	2.3V	1.95			
V_{OL}		$I_{OL} = 100\mu\text{A}$	2.3V- 2.7V			0.2	
		$I_{OH} = 8\text{mA}$	2.3V			0.35	
I_I	All Inputs	$V_I = V_{DD}$ or GND	2.7V			± 5	μA
I_{DD}	Standby (Static)	$\overline{\text{RESET}} = \text{GND}$	2.7V			10	mA
	Operating (Static)	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$				25	
I_{DDD}	Dynamic Operating clock only	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle			30		$\mu\text{A}/$ clock MHz
	Dynamic Operating per each data input	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle			10		$\mu\text{A}/$ clock MHz data input
C_I	Data Inputs	$V_I = V_{REF} \pm 310\text{mV}$	2.5V	2.5		3.5	pF
	CLK and $\overline{\text{CLK}}$	$V_{ICR} = 1.25\text{V}$, $V_{I(\text{PP})} = 360\text{mV}$					
	$\overline{\text{RESET}}$	$V_I = V_{DD}$ or GND		2.5		3.5	

DC Electrical Characteristics for PC3200

(Over the Operating Range, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{DD} = 2.6\text{V} \pm 100\text{mV}$, $V_{DDQ} = 2.6\text{V} \pm 100\text{mV}$)

Parameters		Test Conditions	V_{DD}	Min.	Typ.	Max.	Units
V_{IK}		$I_I = -18\text{mA}$	2.5V			- 1.2	V
V_{OH}		$I_{OH} = -100\mu\text{A}$	2.5V- 2.7V	$V_{DD} - 0.2$			
		$I_{OH} = -8\text{mA}$	2.5V	1.95			
V_{OL}		$I_{OL} = 100\mu\text{A}$	2.5V- 2.7V			0.2	
		$I_{OH} = 8\text{mA}$	2.5V			0.35	
I_I	All Inputs	$V_I = V_{DD}$ or GND	2.7V			± 5	μA
I_{DD}	Standby (Static)	$\overline{\text{RESET}} = \text{GND}$	2.7V			10	
	Operating (Static)	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$				25	mA
I_{DDD}	Dynamic Operating clock only	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle			30		$\mu\text{A}/$ clock MHz
	Dynamic Operating per each data input	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle			10		$\mu\text{A}/$ clock MHz data input
C_I	Data Inputs	$V_I = V_{REF} \pm 310\text{mV}$	2.6V	2.5		3.5	pF
	CLK and $\overline{\text{CLK}}$	$V_{ICR} = 1.25\text{V}$, $V_{I(\text{PP})} = 360\text{mV}$					
	$\overline{\text{RESET}}$	$V_I = V_{DD}$ or GND		2.5		3.5	

Timing Requirements (over recommended operating free-air temperature range, unless otherwise noted)

			V_{DD}=2.5V ±0.2V		V_{DD}=2.6V ±0.1V		Units
			Min.	Max.	Min.	Max.	
f _{clock}	Clock Frequency			270		270	MHz
t _W	Pulse Duration, CLK, CLK High or Low		2.5		2.5		ns
t _{act}	Differential inputs active time, data inputs must be low after RESET High			22		22	
t _{inact}	Differential Inputs inactive time, data and clock inputs must be held at valid levels (not floating) after RESET Low					22	
t _{SU}	Setup time, fast slew rate ^(5,7)	Data before CK ↑, $\overline{\text{CK}}$ ↓	0.75		0.75		
	Setup time, slow slew rate ^(6,7)		0.9		0.9		
t _H	Hold time, fast slew rate ^(5,7)	Data before CK ↑, $\overline{\text{CK}}$ ↓	0.75		0.75		
	Hold time, slow slew rate ^(6,7)		0.9		0.9		

Notes:

5. Data signal input slew rate ≥ 1 V/ns

6. Data signal input slew rate ≥ 0.5V/ns and <1V/ns

7. CLK, CLK input slew rates are ≥ 1 V/ns.

Switching Characteristics for PC1600~PC2700

(over recommended operating free-air temperature range, unless otherwise noted.)

(See test circuits and switching waveforms).

Parameter	From (Input)	To (Output)	V_{DD} = 2.5V ±0.2V			Units
			Min.	Typ.	Max.	
f _{max}			210			MHz
t _{pd}	CLK, $\overline{\text{CLK}}$	Q	1.1		1.8	ns
t _{phl}	$\overline{\text{RESET}}$	Q			5.0	

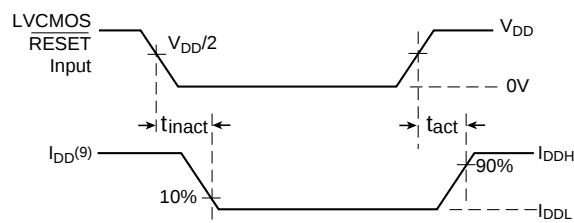
Switching Characteristics for PC3200

(over recommended operating free-air temperature range, unless otherwise noted.)

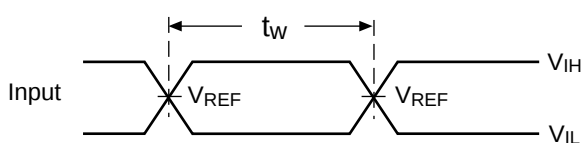
(See test circuits and switching waveforms).

Parameter	From (Input)	To (Output)	V_{DD} = 2.6V ±0.1V			Units
			Min.	Typ.	Max.	
f _{max}			210			MHz
t _{pd}	CLK, $\overline{\text{CLK}}$	Q	1.1		1.8	ns
t _{phl}	$\overline{\text{RESET}}$	Q			5.0	

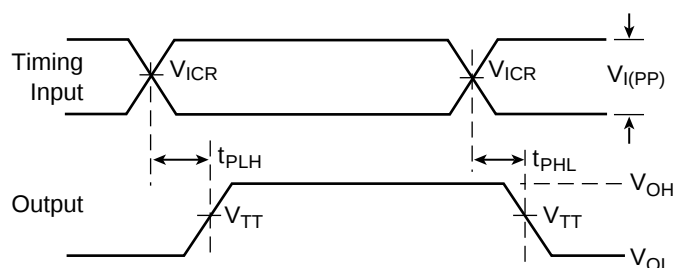
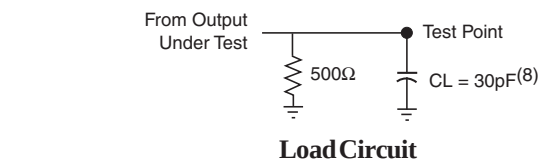
Test Circuit and Switching Waveforms



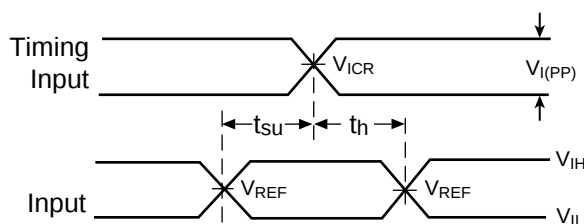
Voltage and Current Waveforms
Input Active and Inactive Times



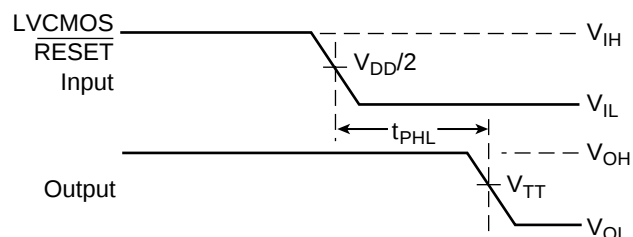
Voltage Waveforms - Pulse Duration



Voltage Waveforms - Propagation Delay Times



Voltage Waveforms - Setup and Hold Times



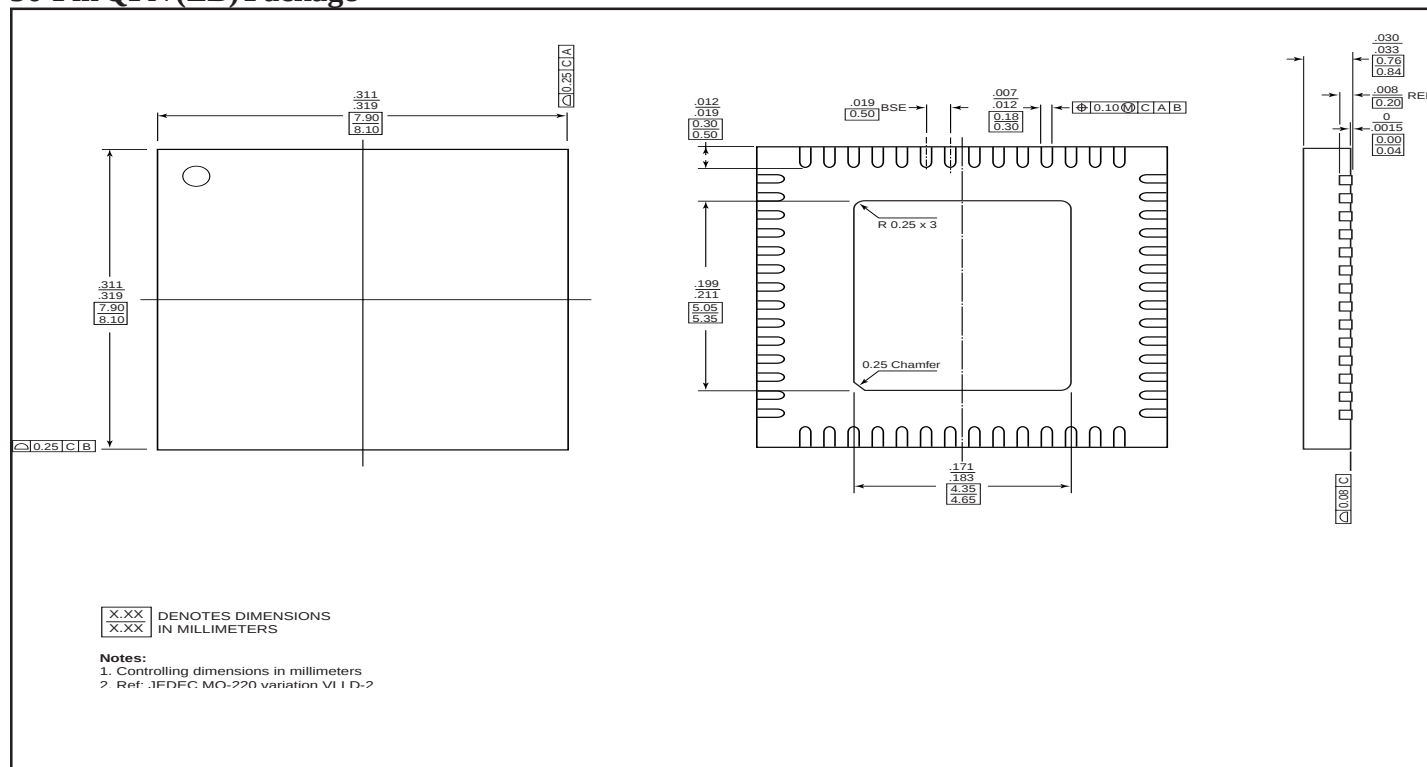
Voltage Waveforms - Propagation Delay Times

Parameter Measurement Information

Notes:

8. C_L includes probe and jig capacitance.
9. I_{DD} tested with clock and data inputs held at V_{DD} or GND, and $I_O = 0\text{mA}$.
10. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\text{ ohms}$.
 Input slew rate = $1\text{V/ns} \pm 20\%$ (unless otherwise specified).
11. The outputs are measured one at a time with one transition per measurement.
12. $V_{TT} = V_{REF} = V_{DDQ}/2$
13. $V_{IH} = V_{REF} + 310\text{mV}$ (ac voltage levels) for SSTL inputs. $V_{IH} = V_{DD}$ for LVC MOS input.
14. $V_{IL} = V_{REF} - 310\text{mV}$ (ac voltage levels) for SSTL inputs. $V_{IL} = \text{GND}$ for LVC MOS input.
15. t_{PLH} and t_{PHL} are the same as t_{pd} .

56-Pin QFN (ZB) Package



Ordering Information

Ordering Code	Package Type	Temperature Range
PI74SSTVF16859AZB	56-Pin QFN	0°C to 70°C
PI74SSTVF16859AZBE	Pb-free 56-Pin QFN	0°C to 70°C

Notes:

1. Thermal characteristics can be found on the company web site at <http://www.pericom.com/packaging/mechanicals.php>
2. X = Tape/Reel